

## Product Summary

Symbol	Value	Unit
$I_{T(RMS)}$	1.0	A
$V_{DRM} V_{RRM}$	600 / 800	V
$I_{GT}$	100	$\mu A$

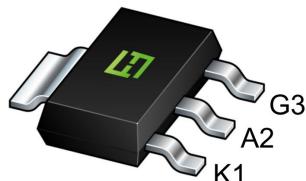
## Feature

With high ability to withstand the shock loading of large current, Provide high dv/dt rate with strong resistance to electromagnetic interference.

## Application

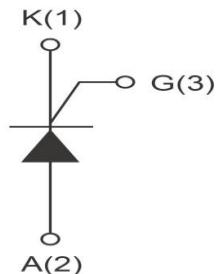
Power charger, T-tools, massager, solid state relay, AC Motor speed regulation and so on.

## Package

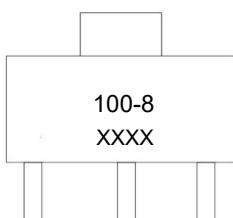


SOT-223-3L

## Circuit diagram



## Marking



**Absolute maximum ratings (Ta=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Repetitive peak off-state voltage	V <sub>DRM</sub>	600 / 800	V
Repetitive peak reverse voltage	V <sub>RRM</sub>	600 / 800	V
RMS on-state current	I <sub>T(RMS)</sub>	1.0	A
Non repetitive surge peak on-state current (full cycle, F=50Hz)	I <sub>TSM</sub>	12	A
I <sup>2</sup> t value for fusing (tp=10ms)	I <sup>2</sup> t	0.72	A <sup>2</sup> s
Critical rate of rise of on-state current (I <sub>G</sub> =2×I <sub>GT</sub> )	dI <sub>T</sub> /dt	50	A/μs
Peak gate current	I <sub>GM</sub>	0.5	A
Average gate power dissipation	P <sub>G(AV)</sub>	0.1	W
Junction Temperature	T <sub>J</sub>	-40 ~ +110	°C
Storage Temperature	T <sub>STG</sub>	-40 ~ +150	°C

**Electrical characteristics (T<sub>A</sub>=25 °C, unless otherwise noted)**

Parameter	Symbol	Test Condition	Value		Unit
			Min	Max	
Gate trigger current	I <sub>GT</sub>	V <sub>D</sub> =12V I <sub>T</sub> =10mA T <sub>j</sub> =25°C	-	100	μA
Gate trigger voltage	V <sub>GT</sub>		-	0.8	V
Gate non-trigger voltage	V <sub>GD</sub>	V <sub>D</sub> =1/2V <sub>DRM</sub> T <sub>j</sub> =110°C	0.2	-	V
latching current	I <sub>L</sub>	V <sub>D</sub> =12V I <sub>G</sub> =0.5mA R <sub>GK</sub> =1kΩ T <sub>j</sub> =25°C	-	5	mA
Holding current	I <sub>H</sub>		-	4	mA
Critical-rate of rise of commutation voltage	dV <sub>D</sub> /dt	V <sub>D</sub> =2/3V <sub>DRM</sub> Gate Open T <sub>j</sub> =110°C	50	-	V/μs

**STATIC CHARACTERISTICS**

Forward "on" voltage	V <sub>TM</sub>	I <sub>TM</sub> =2A tp=380μs	-	1.7	V	
Repetitive Peak Off-State Current	I <sub>DRM</sub>	V <sub>D</sub> =V <sub>DRM</sub> V <sub>R</sub> =V <sub>RRM</sub>	T <sub>j</sub> =25 °C	-	5	μA
Repetitive Peak Reverse Current	I <sub>RRM</sub>		T <sub>j</sub> =110 °C	-	0.1	mA

**THERMAL RESISTANCES**

Thermal resistance	R <sub>th(j-c)</sub>	Junction to case	TYP.	20	°C/W
	R <sub>th(j-a)</sub>	Junction to ambient	TYP.	60	°C/W

## Typical Characteristics

FIG1 Maximum power dissipation versus RMS on-state current

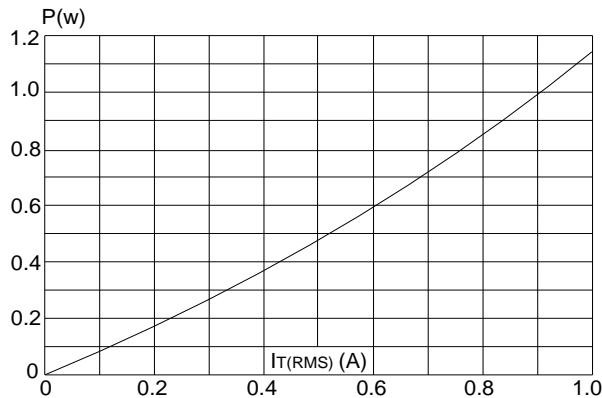


FIG2 RMS on-state current versus case temperature

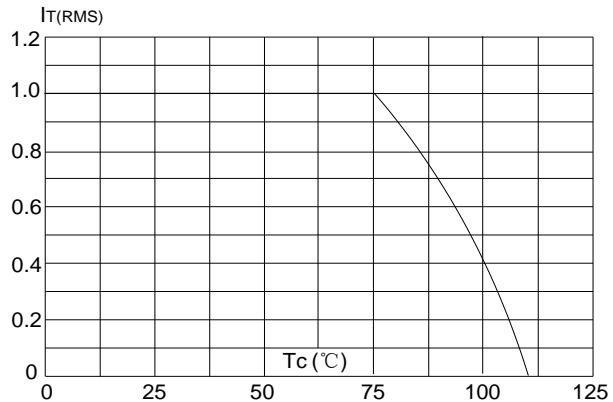


FIG3 Surge peak on-state current versus number of cycles

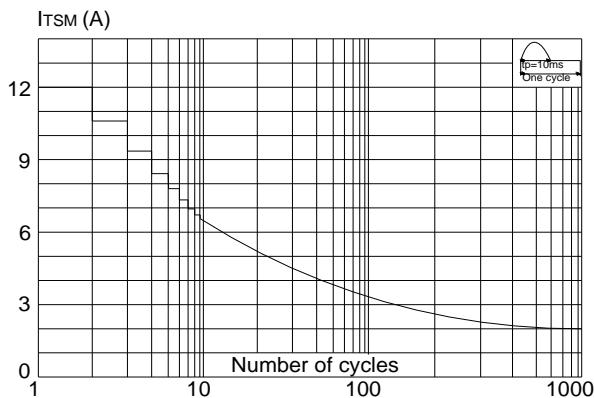


FIG4 On-state characteristics (maximum values)

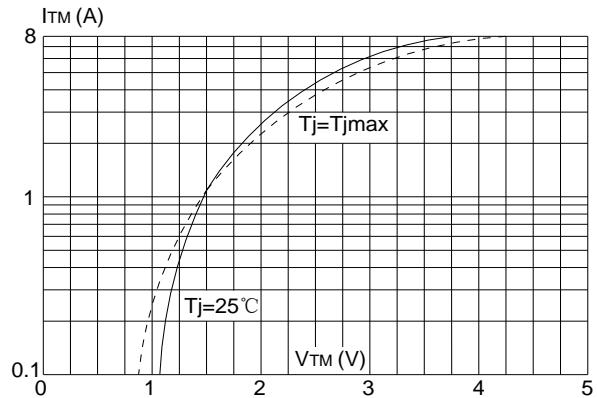


FIG5 Non-repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 20\text{ms}$ , and corresponding value of  $I^2t$  ( $\text{d}I/\text{d}t < 100\text{A}/\mu\text{s}$ )

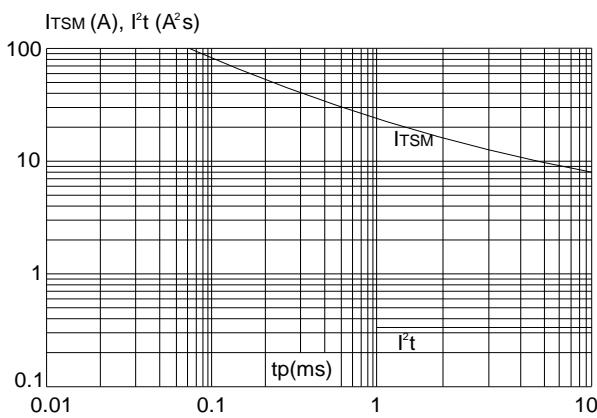
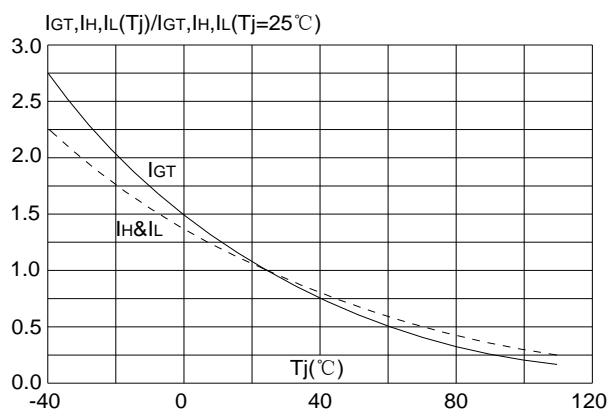


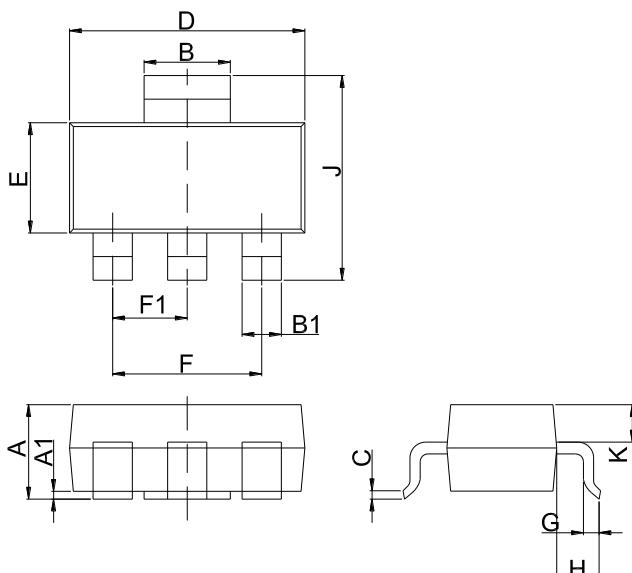
FIG6 Relative variations of gate trigger current, holding current and latching current versus junction temperature



### Ordering Information

**MCR100 – 8 W**  
 SCR<sub>s</sub> I<sub>T(RMS)</sub>: 1.0A  
 8: V<sub>DRM</sub> / V<sub>RRM</sub> ≥ 600V      W:SOT-223-3L

### SOT-223-3L Package Information



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	1.5	1.6	1.8	0.059	0.063	0.071
A1	0	0.06	0.10	0	0.002	0.004
B	2.9	3.0	3.1	0.114	0.118	0.122
B1	0.6	0.7	0.8	0.024	0.028	0.031
C	0.22	0.26	0.32	0.009	0.010	0.013
D	6.3	6.5	6.7	0.248	0.256	0.264
E	3.3	3.5	3.7	0.130	0.138	0.146
F		4.6			0.181	
F1		2.3			0.091	
G	0.7	0.9	1.1	0.028	0.035	0.043
H	1.5	1.75	2.0	0.059	0.069	0.079
J	6.7	7.0	7.3	0.264	0.276	0.287
K	0.8	0.9	1.0	0.031	0.035	0.039